

Search Notes

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------|------|------------------------------------------------------------------------|---------------------------------------------------------|------------------|---------|------------------|
| L1 | 2 | ("6387805").PN. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2004/11/18 22:56 |
| L2 | 2 | ("6472231").PN. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2004/11/18 22:56 |
| S1 | 2 | damascene and cu and ti and titanium adj nitride same self-passivat\$4 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/08 02:41 |
| S2 | 5 | "6716753" | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/08 02:41 |
| S3 | 4 | cu and ti and titanium adj nitride same self-passivat\$4 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/08 02:42 |
| S4 | 5 | cu with ti and tin same self-passivat\$4 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/08 03:06 |
| S5 | 233 | cu with ti and tin and low-k | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/08 03:06 |
| S6 | 176 | damascene and cu with ti and tin and low-k | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/08 03:06 |
| S7 | 161 | dual adj damascene and cu with ti and tin and low-k | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/08 03:06 |

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| S8 | 141 | dual adj damascene and cu with ti and tin and low-k and tan | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/08 03:07 |
| S9 | 23 | dual adj damascene and cu with ti and tin and low-k and tan and passivation adj layer | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/08 03:19 |
| S10 | 22 | dual adj damascene and cu with ti and tin and low-k and tan and passivation adj layer and barrier | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/08 03:19 |
| S11 | 41 | dual adj damascene and cu with ti and tin and low-k and tan and passivation and barrier | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/08 03:20 |
| S12 | 5 | dual adj damascene and cu near ti and tin and low-k and tan and passivation and barrier | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/08 03:21 |
| S13 | 41 | dual adj damascene and cu with ti and tin and low-k and tan and passivation and barrier | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/08 03:21 |
| S14 | 38 | dual adj damascene and cu with ti and tin and low-k and tan with barrier and passivation | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/08 03:21 |
| S15 | 3 | dual adj damascene and cu with ti and low-k and tan with barrier and passivation with tin | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/17 23:59 |
| S16 | 2 | dual adj damascene and cu with ti and low-k and tan with barrier and self adj passivation with tin | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/18 00:00 |
| S17 | 1 | "6472231"-PN: | USPAT; USOCR | OR | ON | 2004/11/18 00:00 |

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| S18 | 2 | dual adj damascene and cu with ti and low-k and self adj passivation with tin | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/18 00:01 |
| S19 | 2 | dual adj damascene and cu with ti and self adj passivation with tin | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/18 00:01 |
| S20 | 2 | dual adj damascene and cu with ti and self adj passivation same tin | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/18 00:01 |
| S21 | 2 | dual adj damascene and cu with ti and self with passivation same tin | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/18 00:01 |
| S22 | 2 | damascene and cu with ti and self with passivation same titanium with nitride | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/18 00:02 |
| S23 | 17 | damascene and cu with ti and passivation same titanium with nitride | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/18 00:02 |
| S24 | 10 | damascene and cu with ti and passivation with titanium with nitride | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/18 00:02 |
| S25 | 1334 | (438/687).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2004/11/18 01:14 |
| S26 | 2038 | (438/656).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2004/11/18 01:15 |
| S27 | 1175 | (257/750).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2004/11/18 01:17 |

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| S28 | 1251 | (257/751).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2004/11/18 01:18 |
| S29 | 2957 | (257/758).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2004/11/18 01:18 |
| S30 | 961 | (257/762).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2004/11/18 01:18 |
| S31 | 9 | "6387805" | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/18 01:18 |
| S32 | 3365 | tantalum adj nitride with barrier | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/18 19:28 |
| S33 | 769 | tantalum adj nitride with barrier and damascene and copper with titanium | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/18 19:28 |
| S34 | 86 | tantalum adj nitride with barrier and damascene and copper near titanium | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/18 19:28 |
| S35 | 54 | tantalum adj nitride with barrier adj layer and damascene and copper near titanium | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/18 19:29 |
| S36 | 2 | tantalum adj nitride with barrier adj layer and damascene and copper near titanium and nitridation | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/18 19:29 |
| S37 | 30 | tantalum adj nitride with barrier adj layer and dual adj damascene and copper near titanium | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/11/18 19:30 |